

ABSTRACT OF THE DISCLOSURE

A heat-dissipating device is used to dissipate heat generated by a component in a computer casing, and includes a flexible tubular conduit and a fan unit. The tubular conduit is adapted to be disposed in the computer casing, and has a first end adapted to be connected to the computer casing such that the first end of the tubular conduit is registered with and communicates fluidly with a vent hole in the computer casing, and a second end opposite to the first end. The fan unit is mounted on the second end of the tubular conduit, and is adapted to be mounted in the computer casing such that the fan unit confronts the component in the computer casing. The fan unit is operable so as to generate air currents that flow through the tubular conduit for cooling the component in the computer casing.